

**PATENT APPLICATION**

Mail Stop Patent Application  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

22386 U.S.PTO  
10/716096  
111803

Sir:

Enclosed herewith for filing under the provisions of 37 C.F.R. §1.53(b) is the following continuation application of the prior, co-pending applications:

United States Patent Application Serial No. 08/808,246, entitled "CHAMBER FOR CONSTRUCTING A FILM ON A SEMICONDUCTOR WAFER", filed on February 28, 1997;  
United States Patent Application Serial No. 08/680,913, entitled "PLASMA BOMBARDING OF THIN FILMS", filed on July 12, 1996;  
United States Patent Application Serial No. 08/677,218, entitled "IN-SITU CONSTRUCTION OF AN OXIDIZED FILM ON A SEMICONDUCTOR WAFER", filed on July 9, 1996;  
United States Patent Application Serial No. 08/677,185, entitled "CHAMBER FOR CONSTRUCTING AN OXIDIZED FILM ON A SEMICONDUCTOR WAFER", filed on July 9, 1996;  
United States Patent Application Serial No. 08/567,461, entitled "PLASMA ANNEALING OF THIN FILMS", filed on December 5, 1995; and  
United States Patent Application Serial No. 08/498,990, entitled "BIASED PLASMA ANNEALING OF THIN FILMS", filed on July 6, 1995

all of which are herein incorporated into the present continuation application by reference in its entirety.

Applicant(s): **Michal Danek**  
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**Title of application:** **CHAMBER FOR CONSTRUCTING A FILM ON A SEMICONDUCTOR WAFER**

Pages of specification: 104 (4 pages of claims and 1 page abstract)

Sheets of drawing: 50

Executed on: \_\_\_\_\_ Docket No.: 761C4/CPI/L/B/PJS

PATENT APPLICATION FILING FEE CALCULATION				
	<u>No.</u>	<u>Filed</u>	<u>Less</u>	<u>Rate/Claim</u>
				<u>Fee</u>
Total Claims	22	-20	2	x \$18.00 \$ 36.00
Independent Claims	2	- 3	0	x \$86.00 \$ 0.00
				Minimum Filing Fee \$ 770.00
				Multiple Dependency Fee (if applicable - \$280.00) \$
				50% Reduction for Small Entity (Independent Inventor, Non-profit Corporation, or Small Business Concern) - appropriate verified statement attached - \$ 0.00
				TOTAL \$1,106.00
				ASSIGNMENT RECORDATION FEE <u>40.00</u>
				<b>TOTAL FILING FEE <u>\$1,146.00</u></b>

Kindly charge the entire and any additional filing fee, as appropriate, to Deposit Account No. 20-0782. To facilitate that charge, a duplicate copy of this letter is enclosed herewith.

**Kindly direct all correspondence to:**

Patent Counsel  
Applied Materials, Inc.  
3050 Bowers Avenue  
P.O. Box 450A  
Santa Clara, CA 95052

Also enclosed herewith for filing in connection with the enclosed application are:

A copy of the executed Declaration for prior Application Serial No. 08/808,246, which remains in effect for the subject continuation application;

Claim(s) to priority under 35 U.S.C. §120:

<u>Serial Number</u>	<u>Filing date</u>
08/808,246	February 28, 1997
08/680,913	July 12, 1996
08/677,218	July 9, 1996

08/677,185 July 9, 1996  
08/567,461 December 5, 1995  
08/498.990 July 6, 1995

At least prior application 08/808,246 is co-pending.

A copy of the executed Assignment of the prior application 08/808,246 from the co-inventors to Applied Materials, Inc., remains in effect for the subject continuation application.

50 sheets of formal drawings.

Respectfully submitted,

Nov 18, 2003

Mr. C.

KEITH TABOADA, Attorney  
Reg. No. 45,150

\*\*\*EXPRESS MAIL CERTIFICATION\*\*\*

"Express Mail" mailing label number: EV360626991US  
Date of deposit: November 18, 2003

I hereby certify that this patent application and related papers is being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 C.F.R. 1.10 on the date indicated above and is addressed to Mail Stop Patent Application, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-14150.

Allyson M. Westy  
Signature of person mailing paper or fee

Allyson M. DeVesty  
Name of person mailing paper or fee